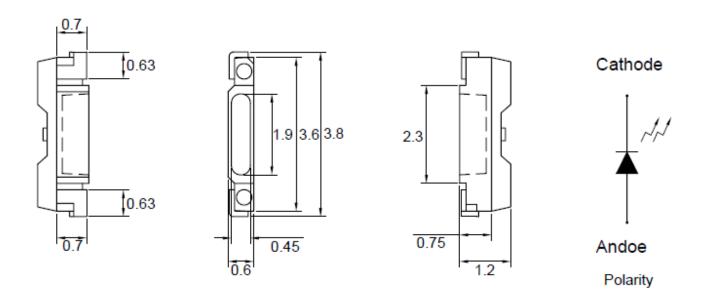


3.8 x 1.2 x 0.6 Blue Right Angle SMD, Tape and Reel

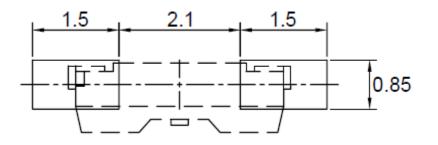
PACKAGE OUTLINES



NOTES:

- 1. All dimension is in millimeter; tolerance ± 0.2 mm unless otherwise noted;
- 2. Specifications are subject to change without notice.

RECOMMENDED SOLDERING PAD DIMENSIONS



NOTES: All dimensions are in millimeter; tolerance ±0.1mm unless otherwise noted

Part Number	Material	Material Lens Color	Color
		Emitted	Lens
L234QBC- TR	InGaN	Blue	Water Clear



3.8 x 1.2 x 0.6 Blue Right Angle SMD, Tape and Reel

ABSOLUTE MAXIMUM RATINGS (Ta=25°			
Parameter	Symbol	Ratings	Unit
Power Dissipation	P _D	108	mW
Peak Forward Current (Duty 1/10@10KHz)	I _{fp}	100	mA
Forward Current	۱ _f	30	mA
Reverse Current @ 5V	١ _r	50	μA
Electrostatic Discharge	ESD	500	V
Operating temperature range	T _{opr}	-20~+80	°C
Storage temperature range	T _{stg}	-30~+100	°C
LED Junction Temperature	Tj	115	°C
Thermal Resistance	R_{th}^{j-s}	60	°C/W

OPTICAL-ELECTRICAL CHARACTERISTICS

Symbol **Test Condition** Min Max Unit Parameter Тур Luminous Intensity mcd 125 200 \mathbf{I}_{v} --Dominant Wavelength 455 $\lambda_{\rm D}$ nm ----Spectral Line Half-Width Δλ 30 ---nm I_F=20mA Forward Voltage Vf 2.8 V ---3.6 $2\Theta \frac{1}{2}$ Viewing angle --120 --Deg

*Note: 1. The forward voltage data did not include ±0.1V testing tolerance.

2. The luminous intensity data did not include ±15% testing tolerance.

(Ta=25°C)



3.8 x 1.2 x 0.6 Blue Right Angle SMD, Tape and Reel

TYPICAL ELECTRO-OPTICAL CHARACTERISTIC CURVES

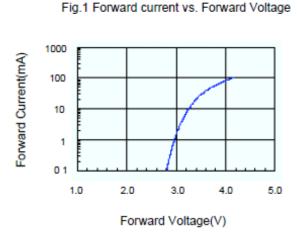


Fig.3 Forward Voltage vs. Temperature

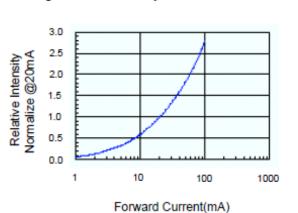


Fig.2 Relative Intensity vs. Forward Current

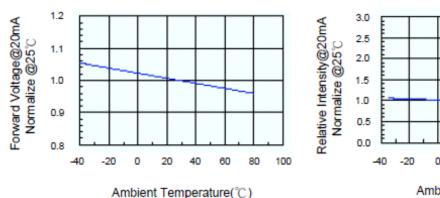


Fig.5 Relative Intensity vs. Wavelength

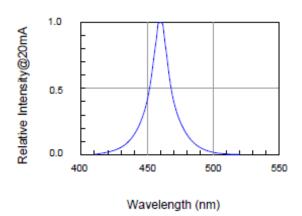


Fig.4 Relative Intensity vs. Temperature

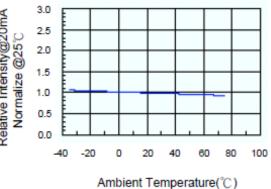
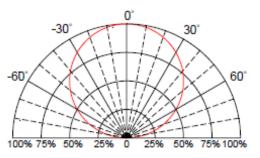


Fig.6 Directive Radiation





3.8 x 1.2 x 0.6 Blue Right Angle SMD, Tape and Reel

BIN CODE LIST

I_F=20mA

Luminous Intensity Classification		Unit: mcd
BIN Code	Min.	Max.
R	125	200
S	200	320
Т	320	500
U	500	800

		I _F =20	0mA
Dominant Wa	avelength Classification	Unit: nm	
Bin Code	Min.	Max.	
01	450	453	
0H	453	456	
0G	456	459	
0F	459	462	

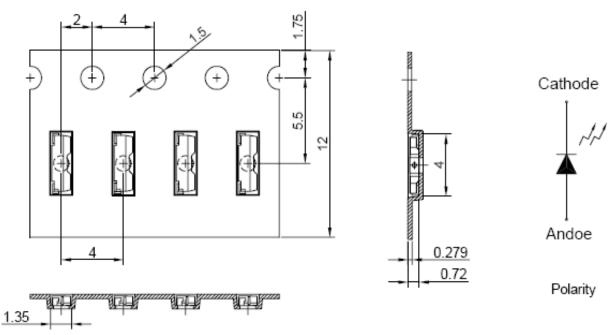
I_F=20mA

		IF 2011/1
Forward	Voltage Classification	Unit: V
BIN Code	Min.	Max.
1	2.8	3.0
2	3.0	3.2
3	3.2	3.4
4	3.4	3.6



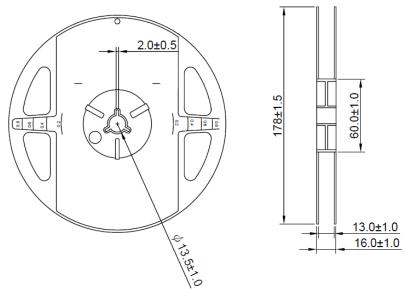
3.8 x 1.2 x 0.6 Blue Right Angle SMD, Tape and Reel

CARRIER TAPE DIMENSION



Note: The tolerances unless mentioned are ±0.1mm, Angle ±0.5

REEL DIMENSIONS



Notes:

1. 3000 pieces per reel.



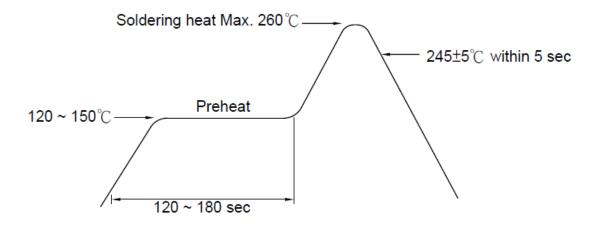
3.8 x 1.2 x 0.6 Blue Right Angle SMD, Tape and Reel

RECOMMENDED SOLDERING CONDITIONS

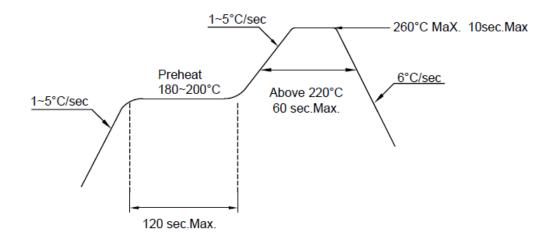
1. Hand Solder

Basis spec is $\leq 320^{\circ}$ C for 3 sec

2. Wave Solder



3. PB-Free Reflow Solder



Notes:

- 1. Reflow soldering should not be done more than two times.
- 2. When soldering, do not put stress on the LEDs during heating.
- 3. After soldering, do not warp the circuit board.



3.8 x 1.2 x 0.6 Blue Right Angle SMD, Tape and Reel

PRECAUTIONS FOR USE

Storage Time:

- 1. The operation of temperatures and RH are: 5°C~35°C, RH60%.
- 2. Once the package is opened, the products should be used within a week. Otherwise, they should be kept in a damp proof box with descanting agent. Considering the tape life, we suggest our customers to use our products within a year (from production date).
- 3. If opened more than one week in an atmosphere 5°C~35°C, RH60%, they should be treated at 60°C±5°C for 15hrs.

Drive Method:

LED is a current operated device, and therefore, require some kind of current limiting incorporated into the driver circuit. This current limiting typically takes the form of a current limiting resistor placed in a series with the LED.

Consider worst case voltage variations that could occur across the current limiting resistor. The forward current should not be allowed to change by more than 40% of its desired value.



(A) Recommended circuit.

(B) The difference of brightness between LED could be found due to the VF-IF characteristics of LED.

Cleaning:

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED.

ESD (Electrostatic Discharge):

Static Electricity or power surge will damage the LED. Use of a conductive wrist band or anti-electrostatic glove is recommended when handling these LEDs. All devices and machinery must be properly grounded.



3.8 x 1.2 x 0.6 Blue Right Angle SMD, Tape and Reel

RELIABILITY TEST:

(1) Test items and results

Classification	Test Item	Test Conditions	Sample Size
Endurance Test	Operating Life Test	 Ta=under room temperature as per data sheet maximum rating If=20mA t=1000 hrs 	22
	High Temperature Storage Test	1. Ta=105°C±5°C 2. t=500 hrs	22
	Low Temperature Storage Test	1. Ta=40°C±5°C 2. t=1000 hrs	22
	High Temperature High Humidity Storage Test	1. IR-Reflow in-board, 2 times 2. Ta=85°C±5°C 3. RH=90%~95% 4. t=500hrs±2hrs	22
Environmental Test	Thermal Shock Test	 IR-Reflow in-board, 2 times Ta=105°C±5°C & -40°C±5°C (30min) (30min) Total 100 cycles 	22
	Reflow Soldering Test	1. Tsol=260°C±5°C 2. Dwell time = 10 max	22
	Temperature Cycling	1. 105°C ~ 25°C ~ -40°C 30 mins 15 mins 30 mins 2. 100 cycles	22

(2) Criteria for judging the damage

Item Symbol	Symbol	Test Conditions	Criteria for Judgement	
	Symbol		Min.	Max.
Forward Voltage	V _f	I _f =20mA		U.S.L. x 1.2
Reverse Current	l _r	V _r =5V		U.S.L. x 2.0
Luminous Intensity	I _v	I _f =20mA	L.S.L. x 0.5	

Note:

1. U.S.L.: Upper Standard Level. 2. L.S.L: Lower Standard Level